

# Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Supply, Demand and Key Producers, 2023-2029

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## Abstracts

The global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market size is expected to reach \$ 461.9 million by 2029, rising at a market growth of 4.7% CAGR during the forecast period (2023-2029).

This report studies the global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing, and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2022 as the base year.

This report explores demand trends and competition, as well as details the characteristics of Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing total production and demand, 2018-2029, (Tons)

Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing total production value, 2018-2029, (USD Million)

Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing production by region & country, production, value, CAGR, 2018-2029, (USD Million) & (Tons)

*Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Supply, Demand and Key Producers...*

Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing consumption by region & country, CAGR, 2018-2029 & (Tons)

U.S. VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing domestic production, consumption, key domestic manufacturers and share

Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing production by manufacturer, production, price, value and market share 2018-2023, (USD Million) & (Tons)

Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing production by Purity, production, value, CAGR, 2018-2029, (USD Million) & (Tons)

Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing production by Application production, value, CAGR, 2018-2029, (USD Million) & (Tons)

This reports profiles key players in the global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market based on the following parameters – company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include JX Nippon Mining & Metals Corporation, Materion, TANAKA, Hitachi Metals, Plansee SE, Luoyang Sifon Electronic Materials, Sumitomo Chemical, Konfoong Materials International and Linde, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals, COVID-19 and Russia-Ukraine War Influence.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (Tons) and average price (US\$/Ton) by manufacturer, by Purity, and by Application. Data is given for the years 2018-2029 by year with 2022 as the base year, 2023 as the estimate year, and 2024-2029 as the forecast year.

## Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

## Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market, Segmentation by Purity

5N

5N5

6N

Others

## Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market, Segmentation by Application

IDM

OSAT

**Companies Profiled:**

JX Nippon Mining & Metals Corporation

Materion

TANAKA

Hitachi Metals

Plansee SE

Luoyang Sifon Electronic Materials

Sumitomo Chemical

Konfoong Materials International

Linde

TOSOH

Honeywell

ULVAC

Advantec

Fujian Acetron New Materials

Changzhou Sujing Electronic Material

GRIKIN Advanced Material

Umicore

Angstrom Sciences

## HC Starck Solutions

### Key Questions Answered

1. How big is the global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market?
2. What is the demand of the global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market?
3. What is the year over year growth of the global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market?
4. What is the production and production value of the global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market?
5. Who are the key producers in the global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing market?
6. What are the growth factors driving the market demand?

## Contents

### 1 SUPPLY SUMMARY

1.1 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Introduction

1.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Supply & Forecast

1.2.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value (2018 & 2022 & 2029)

1.2.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029)

1.2.3 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Pricing Trends (2018-2029)

1.3 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Region (Based on Production Site)

1.3.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Region (2018-2029)

1.3.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Region (2018-2029)

1.3.3 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Region (2018-2029)

1.3.4 North America Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029)

1.3.5 Europe Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029)

1.3.6 China Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029)

1.3.7 Japan Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029)

1.4 Market Drivers, Restraints and Trends

1.4.1 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market Drivers

1.4.2 Factors Affecting Demand

1.4.3 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Major Market Trends

1.5 Influence of COVID-19 and Russia-Ukraine War

1.5.1 Influence of COVID-19

1.5.2 Influence of Russia-Ukraine War

## **2 DEMAND SUMMARY**

2.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Demand (2018-2029)

2.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption by Region

2.2.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption by Region (2018-2023)

2.2.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Forecast by Region (2024-2029)

2.3 United States Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029)

2.4 China Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029)

2.5 Europe Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029)

2.6 Japan Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029)

2.7 South Korea Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029)

2.8 ASEAN Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029)

2.9 India Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029)

## **3 WORLD ULTRA-HIGH PURITY METAL SPUTTERING TARGETS FOR IC ASSEMBLY AND TESTING MANUFACTURERS COMPETITIVE ANALYSIS**

3.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Manufacturer (2018-2023)

3.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Manufacturer (2018-2023)

3.3 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Manufacturer (2018-2023)

3.4 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Company Evaluation Quadrant

3.5 Industry Rank and Concentration Rate (CR)

3.5.1 Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Industry Rank of Major Manufacturers

3.5.2 Global Concentration Ratios (CR4) for Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing in 2022

3.5.3 Global Concentration Ratios (CR8) for Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing in 2022

3.6 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market: Overall Company Footprint Analysis

3.6.1 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market: Region Footprint

3.6.2 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market: Company Product Type Footprint

3.6.3 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market: Company Product Application Footprint

3.7 Competitive Environment

3.7.1 Historical Structure of the Industry

3.7.2 Barriers of Market Entry

3.7.3 Factors of Competition

3.8 New Entrant and Capacity Expansion Plans

3.9 Mergers, Acquisition, Agreements, and Collaborations

## **4 UNITED STATES VS CHINA VS REST OF THE WORLD**

4.1 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Comparison

4.1.1 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Comparison (2018 & 2022 & 2029)

4.1.2 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share Comparison (2018 & 2022 & 2029)

4.2 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Comparison

4.2.1 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Comparison (2018 & 2022 & 2029)

4.2.2 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share Comparison (2018 & 2022 & 2029)

4.3 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Comparison

4.3.1 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Comparison (2018 & 2022 & 2029)

4.3.2 United States VS China: Ultra-high Purity Metal Sputtering Targets for IC



Assembly and Testing Consumption Market Share Comparison (2018 & 2022 & 2029)

4.4 United States Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers and Market Share, 2018-2023

4.4.1 United States Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers, Headquarters and Production Site (States, Country)

4.4.2 United States Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value (2018-2023)

4.4.3 United States Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2023)

4.5 China Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers and Market Share

4.5.1 China Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers, Headquarters and Production Site (Province, Country)

4.5.2 China Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value (2018-2023)

4.5.3 China Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2023)

4.6 Rest of World Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers and Market Share, 2018-2023

4.6.1 Rest of World Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers, Headquarters and Production Site (State, Country)

4.6.2 Rest of World Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value (2018-2023)

4.6.3 Rest of World Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2023)

## **5 MARKET ANALYSIS BY PURITY**

5.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market Size Overview by Purity: 2018 VS 2022 VS 2029

5.2 Segment Introduction by Purity

5.2.1 5N

5.2.2 5N5

5.2.3 6N

5.2.4 Others

5.3 Market Segment by Purity

5.3.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Purity (2018-2029)

5.3.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing

Production Value by Purity (2018-2029)

5.3.3 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing  
Average Price by Purity (2018-2029)

## **6 MARKET ANALYSIS BY APPLICATION**

6.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing  
Market Size Overview by Application: 2018 VS 2022 VS 2029

6.2 Segment Introduction by Application

6.2.1 IDM

6.2.2 OSAT

6.3 Market Segment by Application

6.3.1 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing  
Production by Application (2018-2029)

6.3.2 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing  
Production Value by Application (2018-2029)

6.3.3 World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing  
Average Price by Application (2018-2029)

## **7 COMPANY PROFILES**

7.1 JX Nippon Mining & Metals Corporation

7.1.1 JX Nippon Mining & Metals Corporation Details

7.1.2 JX Nippon Mining & Metals Corporation Major Business

7.1.3 JX Nippon Mining & Metals Corporation Ultra-high Purity Metal Sputtering  
Targets for IC Assembly and Testing Product and Services

7.1.4 JX Nippon Mining & Metals Corporation Ultra-high Purity Metal Sputtering  
Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and  
Market Share (2018-2023)

7.1.5 JX Nippon Mining & Metals Corporation Recent Developments/Updates

7.1.6 JX Nippon Mining & Metals Corporation Competitive Strengths & Weaknesses

7.2 Materion

7.2.1 Materion Details

7.2.2 Materion Major Business

7.2.3 Materion Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing  
Product and Services

7.2.4 Materion Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing  
Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.2.5 Materion Recent Developments/Updates

## 7.2.6 Materion Competitive Strengths & Weaknesses

## 7.3 TANAKA

### 7.3.1 TANAKA Details

### 7.3.2 TANAKA Major Business

### 7.3.3 TANAKA Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

### 7.3.4 TANAKA Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.3.5 TANAKA Recent Developments/Updates

### 7.3.6 TANAKA Competitive Strengths & Weaknesses

## 7.4 Hitachi Metals

### 7.4.1 Hitachi Metals Details

### 7.4.2 Hitachi Metals Major Business

### 7.4.3 Hitachi Metals Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

### 7.4.4 Hitachi Metals Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.4.5 Hitachi Metals Recent Developments/Updates

### 7.4.6 Hitachi Metals Competitive Strengths & Weaknesses

## 7.5 Plansee SE

### 7.5.1 Plansee SE Details

### 7.5.2 Plansee SE Major Business

### 7.5.3 Plansee SE Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

### 7.5.4 Plansee SE Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.5.5 Plansee SE Recent Developments/Updates

### 7.5.6 Plansee SE Competitive Strengths & Weaknesses

## 7.6 Luoyang Sifon Electronic Materials

### 7.6.1 Luoyang Sifon Electronic Materials Details

### 7.6.2 Luoyang Sifon Electronic Materials Major Business

### 7.6.3 Luoyang Sifon Electronic Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

### 7.6.4 Luoyang Sifon Electronic Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

### 7.6.5 Luoyang Sifon Electronic Materials Recent Developments/Updates

### 7.6.6 Luoyang Sifon Electronic Materials Competitive Strengths & Weaknesses

## 7.7 Sumitomo Chemical

- 7.7.1 Sumitomo Chemical Details
- 7.7.2 Sumitomo Chemical Major Business
- 7.7.3 Sumitomo Chemical Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- 7.7.4 Sumitomo Chemical Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)
- 7.7.5 Sumitomo Chemical Recent Developments/Updates
- 7.7.6 Sumitomo Chemical Competitive Strengths & Weaknesses
- 7.8 Konfoong Materials International
  - 7.8.1 Konfoong Materials International Details
  - 7.8.2 Konfoong Materials International Major Business
  - 7.8.3 Konfoong Materials International Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
  - 7.8.4 Konfoong Materials International Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.8.5 Konfoong Materials International Recent Developments/Updates
  - 7.8.6 Konfoong Materials International Competitive Strengths & Weaknesses
- 7.9 Linde
  - 7.9.1 Linde Details
  - 7.9.2 Linde Major Business
  - 7.9.3 Linde Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
  - 7.9.4 Linde Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.9.5 Linde Recent Developments/Updates
  - 7.9.6 Linde Competitive Strengths & Weaknesses
- 7.10 TOSOH
  - 7.10.1 TOSOH Details
  - 7.10.2 TOSOH Major Business
  - 7.10.3 TOSOH Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
  - 7.10.4 TOSOH Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)
  - 7.10.5 TOSOH Recent Developments/Updates
  - 7.10.6 TOSOH Competitive Strengths & Weaknesses
- 7.11 Honeywell
  - 7.11.1 Honeywell Details
  - 7.11.2 Honeywell Major Business

7.11.3 Honeywell Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.11.4 Honeywell Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.11.5 Honeywell Recent Developments/Updates

7.11.6 Honeywell Competitive Strengths & Weaknesses

7.12 ULVAC

7.12.1 ULVAC Details

7.12.2 ULVAC Major Business

7.12.3 ULVAC Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.12.4 ULVAC Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.12.5 ULVAC Recent Developments/Updates

7.12.6 ULVAC Competitive Strengths & Weaknesses

7.13 Advantec

7.13.1 Advantec Details

7.13.2 Advantec Major Business

7.13.3 Advantec Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.13.4 Advantec Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.13.5 Advantec Recent Developments/Updates

7.13.6 Advantec Competitive Strengths & Weaknesses

7.14 Fujian Acetron New Materials

7.14.1 Fujian Acetron New Materials Details

7.14.2 Fujian Acetron New Materials Major Business

7.14.3 Fujian Acetron New Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.14.4 Fujian Acetron New Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.14.5 Fujian Acetron New Materials Recent Developments/Updates

7.14.6 Fujian Acetron New Materials Competitive Strengths & Weaknesses

7.15 Changzhou Sujing Electronic Material

7.15.1 Changzhou Sujing Electronic Material Details

7.15.2 Changzhou Sujing Electronic Material Major Business

7.15.3 Changzhou Sujing Electronic Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.15.4 Changzhou Sujing Electronic Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.15.5 Changzhou Sujing Electronic Material Recent Developments/Updates

7.15.6 Changzhou Sujing Electronic Material Competitive Strengths & Weaknesses

7.16 GRIKIN Advanced Material

7.16.1 GRIKIN Advanced Material Details

7.16.2 GRIKIN Advanced Material Major Business

7.16.3 GRIKIN Advanced Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.16.4 GRIKIN Advanced Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.16.5 GRIKIN Advanced Material Recent Developments/Updates

7.16.6 GRIKIN Advanced Material Competitive Strengths & Weaknesses

7.17 Umicore

7.17.1 Umicore Details

7.17.2 Umicore Major Business

7.17.3 Umicore Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.17.4 Umicore Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.17.5 Umicore Recent Developments/Updates

7.17.6 Umicore Competitive Strengths & Weaknesses

7.18 Angstrom Sciences

7.18.1 Angstrom Sciences Details

7.18.2 Angstrom Sciences Major Business

7.18.3 Angstrom Sciences Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.18.4 Angstrom Sciences Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.18.5 Angstrom Sciences Recent Developments/Updates

7.18.6 Angstrom Sciences Competitive Strengths & Weaknesses

7.19 HC Starck Solutions

7.19.1 HC Starck Solutions Details

7.19.2 HC Starck Solutions Major Business

7.19.3 HC Starck Solutions Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

7.19.4 HC Starck Solutions Ultra-high Purity Metal Sputtering Targets for IC Assembly

and Testing Production, Price, Value, Gross Margin and Market Share (2018-2023)

7.19.5 HC Starck Solutions Recent Developments/Updates

7.19.6 HC Starck Solutions Competitive Strengths & Weaknesses

## **8 INDUSTRY CHAIN ANALYSIS**

8.1 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Industry Chain

8.2 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Upstream Analysis

8.2.1 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Core Raw Materials

8.2.2 Main Manufacturers of Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Core Raw Materials

8.3 Midstream Analysis

8.4 Downstream Analysis

8.5 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Mode

8.6 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Procurement Model

8.7 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Industry Sales Model and Sales Channels

8.7.1 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Sales Model

8.7.2 Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Typical Customers

## **9 RESEARCH FINDINGS AND CONCLUSION**

## **10 APPENDIX**

10.1 Methodology

10.2 Research Process and Data Source

10.3 Disclaimer

## List Of Tables

### LIST OF TABLES

Table 1. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Region (2018, 2022 and 2029) & (USD Million)

Table 2. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Region (2018-2023) & (USD Million)

Table 3. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Region (2024-2029) & (USD Million)

Table 4. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share by Region (2018-2023)

Table 5. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share by Region (2024-2029)

Table 6. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Region (2018-2023) & (Tons)

Table 7. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Region (2024-2029) & (Tons)

Table 8. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share by Region (2018-2023)

Table 9. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share by Region (2024-2029)

Table 10. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Region (2018-2023) & (US\$/Ton)

Table 11. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Region (2024-2029) & (US\$/Ton)

Table 12. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Major Market Trends

Table 13. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Growth Rate Forecast by Region (2018 & 2022 & 2029) & (Tons)

Table 14. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption by Region (2018-2023) & (Tons)

Table 15. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Forecast by Region (2024-2029) & (Tons)

Table 16. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Manufacturer (2018-2023) & (USD Million)

Table 17. Production Value Market Share of Key Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Producers in 2022

Table 18. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing



Production by Manufacturer (2018-2023) & (Tons)

Table 19. Production Market Share of Key Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Producers in 2022

Table 20. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Manufacturer (2018-2023) & (US\$/Ton)

Table 21. Global Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Company Evaluation Quadrant

Table 22. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Industry Rank of Major Manufacturers, Based on Production Value in 2022

Table 23. Head Office and Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Site of Key Manufacturer

Table 24. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market: Company Product Type Footprint

Table 25. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market: Company Product Application Footprint

Table 26. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Competitive Factors

Table 27. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing New Entrant and Capacity Expansion Plans

Table 28. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Mergers & Acquisitions Activity

Table 29. United States VS China Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Comparison, (2018 & 2022 & 2029) & (USD Million)

Table 30. United States VS China Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Comparison, (2018 & 2022 & 2029) & (Tons)

Table 31. United States VS China Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Comparison, (2018 & 2022 & 2029) & (Tons)

Table 32. United States Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers, Headquarters and Production Site (States, Country)

Table 33. United States Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value, (2018-2023) & (USD Million)

Table 34. United States Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share (2018-2023)

Table 35. United States Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2023) & (Tons)

Table 36. United States Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share (2018-2023)

- Table 37. China Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers, Headquarters and Production Site (Province, Country)
- Table 38. China Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value, (2018-2023) & (USD Million)
- Table 39. China Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share (2018-2023)
- Table 40. China Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2023) & (Tons)
- Table 41. China Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share (2018-2023)
- Table 42. Rest of World Based Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Manufacturers, Headquarters and Production Site (States, Country)
- Table 43. Rest of World Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value, (2018-2023) & (USD Million)
- Table 44. Rest of World Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share (2018-2023)
- Table 45. Rest of World Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2023) & (Tons)
- Table 46. Rest of World Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share (2018-2023)
- Table 47. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Purity, (USD Million), 2018 & 2022 & 2029
- Table 48. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Purity (2018-2023) & (Tons)
- Table 49. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Purity (2024-2029) & (Tons)
- Table 50. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Purity (2018-2023) & (USD Million)
- Table 51. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Purity (2024-2029) & (USD Million)
- Table 52. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Purity (2018-2023) & (US\$/Ton)
- Table 53. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Purity (2024-2029) & (US\$/Ton)
- Table 54. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Application, (USD Million), 2018 & 2022 & 2029
- Table 55. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Application (2018-2023) & (Tons)

Table 56. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production by Application (2024-2029) & (Tons)

Table 57. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Application (2018-2023) & (USD Million)

Table 58. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Application (2024-2029) & (USD Million)

Table 59. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Application (2018-2023) & (US\$/Ton)

Table 60. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Application (2024-2029) & (US\$/Ton)

Table 61. JX Nippon Mining & Metals Corporation Basic Information, Manufacturing Base and Competitors

Table 62. JX Nippon Mining & Metals Corporation Major Business

Table 63. JX Nippon Mining & Metals Corporation Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 64. JX Nippon Mining & Metals Corporation Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 65. JX Nippon Mining & Metals Corporation Recent Developments/Updates

Table 66. JX Nippon Mining & Metals Corporation Competitive Strengths & Weaknesses

Table 67. Materion Basic Information, Manufacturing Base and Competitors

Table 68. Materion Major Business

Table 69. Materion Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 70. Materion Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 71. Materion Recent Developments/Updates

Table 72. Materion Competitive Strengths & Weaknesses

Table 73. TANAKA Basic Information, Manufacturing Base and Competitors

Table 74. TANAKA Major Business

Table 75. TANAKA Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 76. TANAKA Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 77. TANAKA Recent Developments/Updates

Table 78. TANAKA Competitive Strengths & Weaknesses

- Table 79. Hitachi Metals Basic Information, Manufacturing Base and Competitors
- Table 80. Hitachi Metals Major Business
- Table 81. Hitachi Metals Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 82. Hitachi Metals Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 83. Hitachi Metals Recent Developments/Updates
- Table 84. Hitachi Metals Competitive Strengths & Weaknesses
- Table 85. Plansee SE Basic Information, Manufacturing Base and Competitors
- Table 86. Plansee SE Major Business
- Table 87. Plansee SE Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 88. Plansee SE Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 89. Plansee SE Recent Developments/Updates
- Table 90. Plansee SE Competitive Strengths & Weaknesses
- Table 91. Luoyang Sifon Electronic Materials Basic Information, Manufacturing Base and Competitors
- Table 92. Luoyang Sifon Electronic Materials Major Business
- Table 93. Luoyang Sifon Electronic Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 94. Luoyang Sifon Electronic Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 95. Luoyang Sifon Electronic Materials Recent Developments/Updates
- Table 96. Luoyang Sifon Electronic Materials Competitive Strengths & Weaknesses
- Table 97. Sumitomo Chemical Basic Information, Manufacturing Base and Competitors
- Table 98. Sumitomo Chemical Major Business
- Table 99. Sumitomo Chemical Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 100. Sumitomo Chemical Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 101. Sumitomo Chemical Recent Developments/Updates
- Table 102. Sumitomo Chemical Competitive Strengths & Weaknesses
- Table 103. Konfoong Materials International Basic Information, Manufacturing Base and Competitors

- Table 104. Konfoong Materials International Major Business
- Table 105. Konfoong Materials International Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 106. Konfoong Materials International Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 107. Konfoong Materials International Recent Developments/Updates
- Table 108. Konfoong Materials International Competitive Strengths & Weaknesses
- Table 109. Linde Basic Information, Manufacturing Base and Competitors
- Table 110. Linde Major Business
- Table 111. Linde Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 112. Linde Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 113. Linde Recent Developments/Updates
- Table 114. Linde Competitive Strengths & Weaknesses
- Table 115. TOSOH Basic Information, Manufacturing Base and Competitors
- Table 116. TOSOH Major Business
- Table 117. TOSOH Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 118. TOSOH Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 119. TOSOH Recent Developments/Updates
- Table 120. TOSOH Competitive Strengths & Weaknesses
- Table 121. Honeywell Basic Information, Manufacturing Base and Competitors
- Table 122. Honeywell Major Business
- Table 123. Honeywell Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services
- Table 124. Honeywell Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)
- Table 125. Honeywell Recent Developments/Updates
- Table 126. Honeywell Competitive Strengths & Weaknesses
- Table 127. ULVAC Basic Information, Manufacturing Base and Competitors
- Table 128. ULVAC Major Business
- Table 129. ULVAC Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 130. ULVAC Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 131. ULVAC Recent Developments/Updates

Table 132. ULVAC Competitive Strengths & Weaknesses

Table 133. Advantec Basic Information, Manufacturing Base and Competitors

Table 134. Advantec Major Business

Table 135. Advantec Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 136. Advantec Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 137. Advantec Recent Developments/Updates

Table 138. Advantec Competitive Strengths & Weaknesses

Table 139. Fujian Acetron New Materials Basic Information, Manufacturing Base and Competitors

Table 140. Fujian Acetron New Materials Major Business

Table 141. Fujian Acetron New Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 142. Fujian Acetron New Materials Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 143. Fujian Acetron New Materials Recent Developments/Updates

Table 144. Fujian Acetron New Materials Competitive Strengths & Weaknesses

Table 145. Changzhou Sujing Electronic Material Basic Information, Manufacturing Base and Competitors

Table 146. Changzhou Sujing Electronic Material Major Business

Table 147. Changzhou Sujing Electronic Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 148. Changzhou Sujing Electronic Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 149. Changzhou Sujing Electronic Material Recent Developments/Updates

Table 150. Changzhou Sujing Electronic Material Competitive Strengths & Weaknesses

Table 151. GRIKIN Advanced Material Basic Information, Manufacturing Base and Competitors

Table 152. GRIKIN Advanced Material Major Business

Table 153. GRIKIN Advanced Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 154. GRIKIN Advanced Material Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 155. GRIKIN Advanced Material Recent Developments/Updates

Table 156. GRIKIN Advanced Material Competitive Strengths & Weaknesses

Table 157. Umicore Basic Information, Manufacturing Base and Competitors

Table 158. Umicore Major Business

Table 159. Umicore Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 160. Umicore Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 161. Umicore Recent Developments/Updates

Table 162. Umicore Competitive Strengths & Weaknesses

Table 163. Angstrom Sciences Basic Information, Manufacturing Base and Competitors

Table 164. Angstrom Sciences Major Business

Table 165. Angstrom Sciences Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 166. Angstrom Sciences Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 167. Angstrom Sciences Recent Developments/Updates

Table 168. HC Starck Solutions Basic Information, Manufacturing Base and Competitors

Table 169. HC Starck Solutions Major Business

Table 170. HC Starck Solutions Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Product and Services

Table 171. HC Starck Solutions Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2018-2023)

Table 172. Global Key Players of Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Upstream (Raw Materials)

Table 173. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Typical Customers

Table 174. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Typical Distributors

## List Of Figures

### LIST OF FIGURES

Figure 1. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Picture

Figure 2. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value: 2018 & 2022 & 2029, (USD Million)

Figure 3. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value and Forecast (2018-2029) & (USD Million)

Figure 4. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029) & (Tons)

Figure 5. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price (2018-2029) & (US\$/Ton)

Figure 6. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share by Region (2018-2029)

Figure 7. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share by Region (2018-2029)

Figure 8. North America Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029) & (Tons)

Figure 9. Europe Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029) & (Tons)

Figure 10. China Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029) & (Tons)

Figure 11. Japan Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production (2018-2029) & (Tons)

Figure 12. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Market Drivers

Figure 13. Factors Affecting Demand

Figure 14. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029) & (Tons)

Figure 15. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Market Share by Region (2018-2029)

Figure 16. United States Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029) & (Tons)

Figure 17. China Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029) & (Tons)

Figure 18. Europe Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029) & (Tons)

Figure 19. Japan Ultra-high Purity Metal Sputtering Targets for IC Assembly and



Testing Consumption (2018-2029) & (Tons)

Figure 20. South Korea Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029) & (Tons)

Figure 21. ASEAN Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029) & (Tons)

Figure 22. India Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption (2018-2029) & (Tons)

Figure 23. Producer Shipments of Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing by Manufacturer Revenue (\$MM) and Market Share (%): 2022

Figure 24. Global Four-firm Concentration Ratios (CR4) for Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Markets in 2022

Figure 25. Global Four-firm Concentration Ratios (CR8) for Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Markets in 2022

Figure 26. United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share Comparison (2018 & 2022 & 2029)

Figure 27. United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share Comparison (2018 & 2022 & 2029)

Figure 28. United States VS China: Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Consumption Market Share Comparison (2018 & 2022 & 2029)

Figure 29. United States Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share 2022

Figure 30. China Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share 2022

Figure 31. Rest of World Based Manufacturers Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share 2022

Figure 32. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Purity, (USD Million), 2018 & 2022 & 2029

Figure 33. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share by Purity in 2022

Figure 34. 5N

Figure 35. 5N5

Figure 36. 6N

Figure 37. Others

Figure 38. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share by Purity (2018-2029)

Figure 39. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share by Purity (2018-2029)

Figure 40. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing

Average Price by Purity (2018-2029) & (US\$/Ton)

Figure 41. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value by Application, (USD Million), 2018 & 2022 & 2029

Figure 42. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share by Application in 2022

Figure 43. IDM

Figure 44. OSAT

Figure 45. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Market Share by Application (2018-2029)

Figure 46. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Production Value Market Share by Application (2018-2029)

Figure 47. World Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Average Price by Application (2018-2029) & (US\$/Ton)

Figure 48. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Industry Chain

Figure 49. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Procurement Model

Figure 50. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Sales Model

Figure 51. Ultra-high Purity Metal Sputtering Targets for IC Assembly and Testing Sales Channels, Direct Sales, and Distribution

Figure 52. Methodology

Figure 53. Research Process and Data Source

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